



## **Ordering Information**

BV <sub>DSS</sub> /	R <sub>DS(ON)</sub>	I <sub>D(ON)</sub>	Order Number / Package		
BV <sub>DGS</sub>	(max)	(min)	TO-92		
30V	1.2Ω	1.0A	VN0300L		

#### **Features**

- Free from secondary breakdown
- Low power drive requirement
- Ease of paralleling
- Low C<sub>ISS</sub> and fast switching speeds
- Excellent thermal stability
- Integral Source-Drain diode
- High input impedance and high gain
- Complementary N- and P-channel devices

## **Applications**

- Motor controls
- Converters
- Amplifiers
- Switches
- Power supply circuits
- Drivers (relays, hammers, solenoids, lamps, memories, displays, bipolar transistors, etc.)

#### **Absolute Maximum Ratings**

Drain-to-Source Voltage	$BV_{DSS}$
Drain-to-Gate Voltage	BV <sub>DGS</sub>
Gate-to-Source Voltage	± 30V
Operating and Storage Temperature	-55°C to +150°C
Soldering Temperature*	300°C

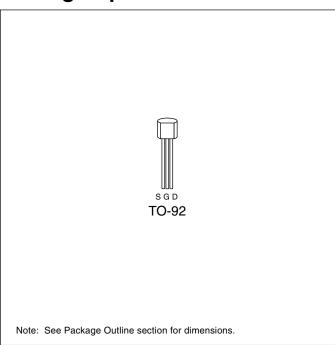
<sup>\*</sup> Distance of 1.6 mm from case for 10 seconds.

## **Advanced DMOS Technology**

These enhancement-mode (normally-off) transistors utilize a vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces devices with the power handling capabilities of bipolar transistors and with the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, these devices are free from thermal runaway and thermally-induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

## **Package Option**



11/12/01

#### **Thermal Characteristics**

Package	I <sub>D</sub> (continuous)*	I <sub>D</sub> (pulsed)	Power Dissipation @ T <sub>C</sub> = 25°C	$^{ heta_{ extsf{jc}}}_{ extsf{^{\circ}} extsf{C/W}}$	$^{ heta_{ja}}_{C/W}$	
TO-92	0.64A	3A	1W	125	170	

<sup>\*</sup> I<sub>D</sub> (continuous) is limited by max rated T<sub>i</sub>.

## Electrical Characteristics (@ 25°C unless otherwise specified)

Symbol	Parameter	Min	Тур	Max	Unit	Conditions	
BV <sub>DSS</sub>	Drain-to-Source Breakdown Voltage	30			V	$V_{GS} = 0V, I_{D} = 10\mu A$	
V <sub>GS(th)</sub>	Gate Threshold Voltage	0.8		2.5	V	$V_{GS} = V_{DS}, I_D = 1mA$	
I <sub>GSS</sub>	Gate Body Leakage			100	nA	$V_{GS} = \pm 30V, V_{DS} = 0V$	
I <sub>DSS</sub>	Zero Gate Voltage Drain Current			10		$V_{GS} = 0V$ , $V_{DS} = Max$ Rating	
				500	μΑ	V <sub>GS</sub> = 0V, V <sub>DS</sub> = 30V T <sub>A</sub> = 125°C	
I <sub>D(ON)</sub>	ON-State Drain Current	1			Α	$V_{GS} = 10V, V_{DS} = 10V$	
R <sub>DS(ON)</sub>	Static Drain-to-Source ON-State Resistance			3.3	Ω	$V_{GS} = 5V, I_D = 0.3A$	
				1.2		$V_{GS} = 10V, I_D = 1A$	
G <sub>FS</sub>	Forward Transconductance	200			m&	$V_{DS} = 10V, I_D = 0.5A$	
C <sub>ISS</sub>	Input Capacitance			190			
C <sub>OSS</sub>	Common Source Output Capacitance			110	pF	$V_{GS} = 0V, V_{DS} = 20V$	
C <sub>RSS</sub>	Reverse Transfer Capacitance			50		f = 1 MHz	
t <sub>(ON)</sub>	Turn-ON Time			30		$V_{DD} = 25V, I_D = 1.0A$	
t <sub>(OFF)</sub>	Turn-OFF Time			30	ns	$R_{GEN} = 25\Omega$	
V <sub>SD</sub>	Diode Forward Voltage Drop		0.9		V	$I_{SD} = 0.63A, V_{GS} = 0V$	

#### Notes:

- 1. All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300µs pulse, 2% duty cycle.)
- 2. All A.C. parameters sample tested.

# **Switching Waveforms and Test Circuit**

